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DATA SHEET

MLG05N-1195H50501

MLG-2
Automation light grids

SICK Sensor Intelligence



Illustration may differ

AUTOMATION LIGHT GRIDS

MLG05N-1195H50501

ORDERING INFORMATION

Type	part no.
MLG05N-1195H50501	1150333

Further device versions and accessories at www.sick.com/MLG-2

DETAILED TECHNICAL DATA

FEATURES

Device version	ProNet – extended functionality including fieldbus
Sensor principle	Sender/receiver
Minimum detectable object (MDO)	5 mm [1] 9 mm [2] [3]
Beam separation	5 mm
Type of synchronization	Cable
Number of beams	240
Detection height	1,195 mm
Software features (default)	
Q_t	Presence detection
Operating mode	
Standard	✓
Transparent	✓
Dust- and sunlight-resistant	✓
Function	
Cross beam	✓
Beam blanking	✓
High-speed scan	✓
High measurement accuracy	✓
Applications	
Switching output	Object detection/object width Object recognition Height classification

[1] MDO min. detectable object at high measurement accuracy.

[2] MDO min. detectable object for standard measurement accuracy.

[3] Depending on beam separation without cross beam setting.

Data interface	Hole detection/hole size Outside/inside dimension Object position Hole position Zone definition Object detection Hole detection Object height measurement Measurement of the outside dimension Measurement of the inside dimension Measurement of the object position Measurement of the hole position
Included with delivery	1 × sender (in IP69K protective pipes) 1 × receiver (in IP69K protective pipes) 1 x Fieldbus module 1 x IP69K mounting instructions
Part number of individual components	2148448 MLGR05N-1195F50201, 2148449 MLGT05A-1195F50101

[1] MDO min. detectable object at high measurement accuracy.

[2] MDO min. detectable object for standard measurement accuracy.

[3] Depending on beam separation without cross beam setting.

MECHANICS/ELECTRONICS

Light source	LED, Infrared light
Wave length	850 nm
Supply voltage V_s	DC 19.2 V ... 28.8 V [1]
Power consumption sender	67 mA [2]
Power consumption receiver	168 mA [2]
Fieldbus module current consumption	115 mA
Ripple	< 5 V_{pp}
Output current $I_{max.}$	100 mA
Output load, capacitive	100 nF
Output load, Inductive	1 H
Initialization time	< 1 s
Switching output	Push-pull: PNP/NPN
Connection type	Plug, M12, 5-pin, 1.4 m Connector M12, 12-pin, 1.4 m
Housing material	Aluminum (light grid) PMMA Plexiglas XT Food Contact DoC (protective pipe) Polypropylene, stainless steel 1.4404 (cable) VA 1.4305 (pressure compensation element) Stainless steel 1.4404 (end caps) Stainless steel V4A 1.4404 DIN EN 1672-2 (cable gland)
Display	LED
Enclosure rating	IP69K [3]
Circuit protection	U_v connections, reverse polarity protected Output Q short-circuit protected Interference pulse suppression
Protection class	III
Weight	2.96 kg
Option	Protective housing IP69K
UL File No.	NRKH.E181493

[1] Without load.

[2] Without load with 24 V.

[3] Operating in outdoor condition only with a external protection housing.

PERFORMANCE

Maximum range	5.25 m [1]
Minimum range	≥ 0 m
Operating range	3.75 m
Response time	19.8 ms [2]

[1] No reserve for environmental issue and deterioration of the diode.

[2] Without high speed.

INTERFACES

EtherNet/IP™	✓
Digital output	Q_1
Number	1

AMBIENT DATA

Shock resistance	Continuous shocks 10 g, 16 ms, 1000 shocks Single shocks 15 g, 11 ms 3 per axle
Vibration resistance	Sinusoidal oscillation 10-150 Hz 5 g
EMC	EN 60947-5-2
Ambient light immunity	Direct: 150,000 lx [1] Indirect: 200,000 lx [2]
Ambient operating temperature	–20 °C ... +55 °C
Ambient temperature, storage	–40 °C ... +70 °C

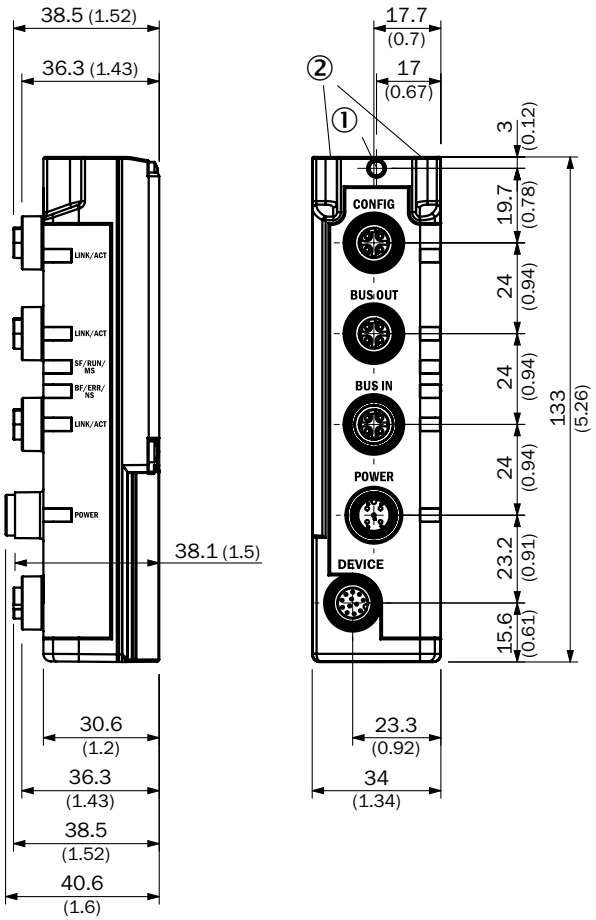
[1] Outdoor mode.

[2] Light resistance indirect.

CERTIFICATES

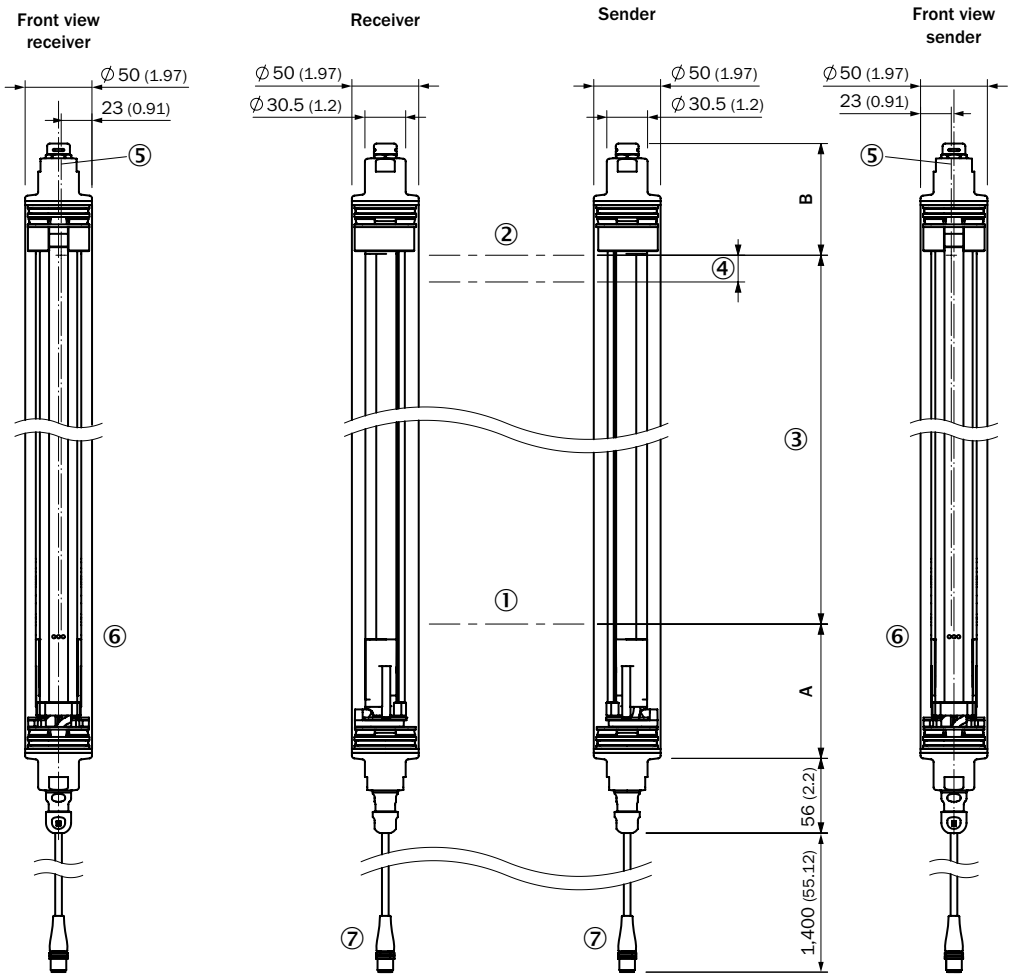
EU declaration of conformity	✓
UK declaration of conformity	✓
ACMA declaration of conformity	✓
Moroccan declaration of conformity	✓
China RoHS	✓
cULus certificate	✓
Profinet certificate	✓
Photobiological safety (IEC EN 62471)	✓
Information according to Art. 3 of Data Act (Regulation EU 2023/2854)	✓

DIMENSIONAL DRAWING PROFINET, ETHERCAT®, ETHERNET/IP



Dimensions in mm (inch)
① safty screw M4; turning moment 0,5 Nm
② for thread bold M4; turning moment 0,5 Nm

DIMENSIONAL DRAWING

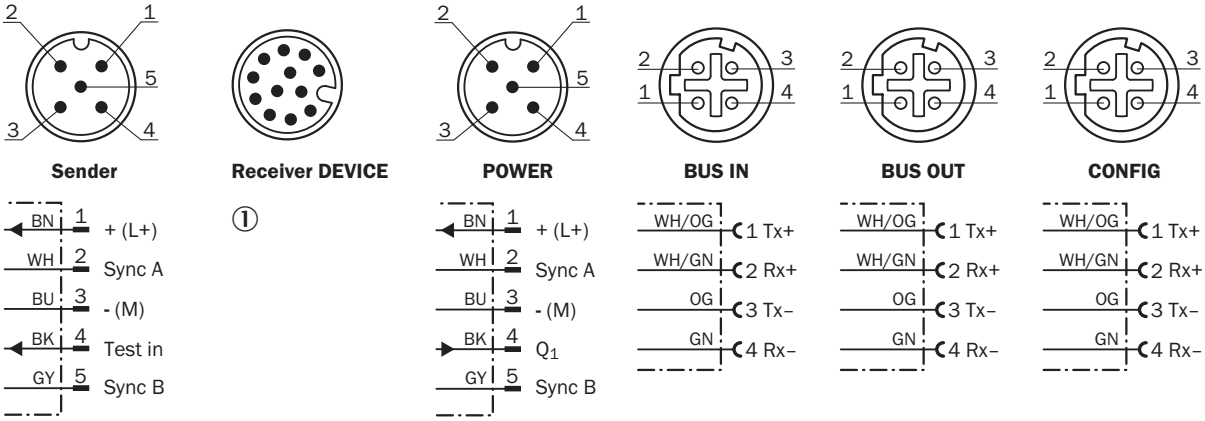


	A [1]	B [2]
Beam separation 2.5 mm	94.25 (3.71)	84.7 (3.33)
Beam separation 5 mm	95.5 (3.76)	83.6 (3.29)
Beam separation 10 mm	100.5 (3.96)	83.6 (3.29)
Beam separation 20 mm	100.5 (3.96)/110.5 (4.35) [3]	83.6 (3.29)
Beam separation 25 mm	115.5 (4.55)	83.6 (3.29)
Beam separation 30 mm	120.5 (4.74)	83.6 (3.29)
Beam separation 50 mm	140.5 (5.53)	83.6 (3.29)

[1] Distance: MLG-2 edge - first beam
[2] Distance: MLG-2 edge - last beam
[3] MLG20x-xx**40**: 100.5 mm
MLG20x-xx**80**: 110.5 mm

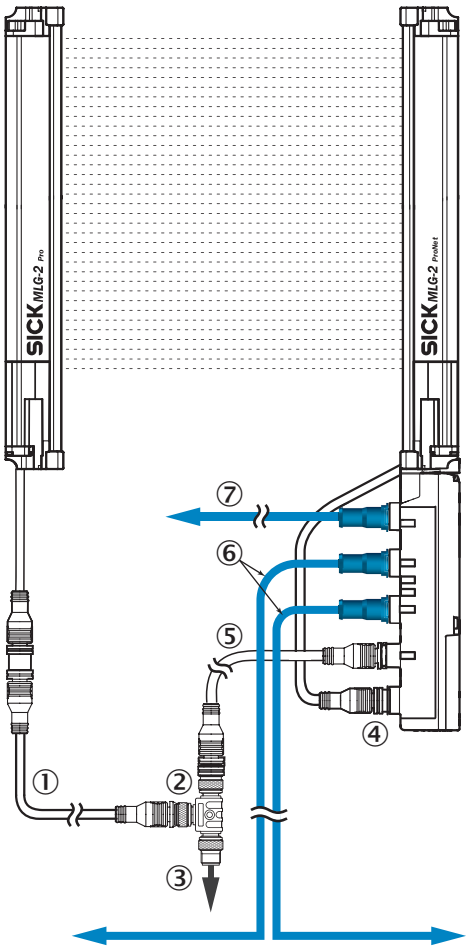
Dimensions in mm (inch)
① First beam
② last beam
③ detection height (see technical data)
④ Beam separation
⑤ Optical axis
⑥ status indicator: green, yellow, red LEDs
⑦ Connection

CONNECTION TYPE AND DIAGRAM PROFINET, ETHERCAT®, ETHERNET/IP



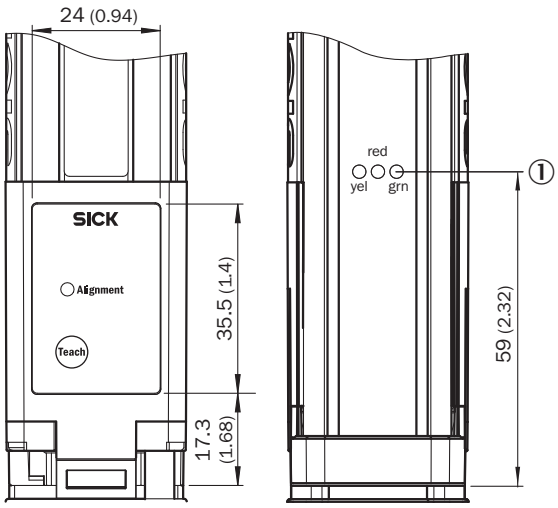
① *Connection to fieldbus module*

PINOUTS ETHERNET



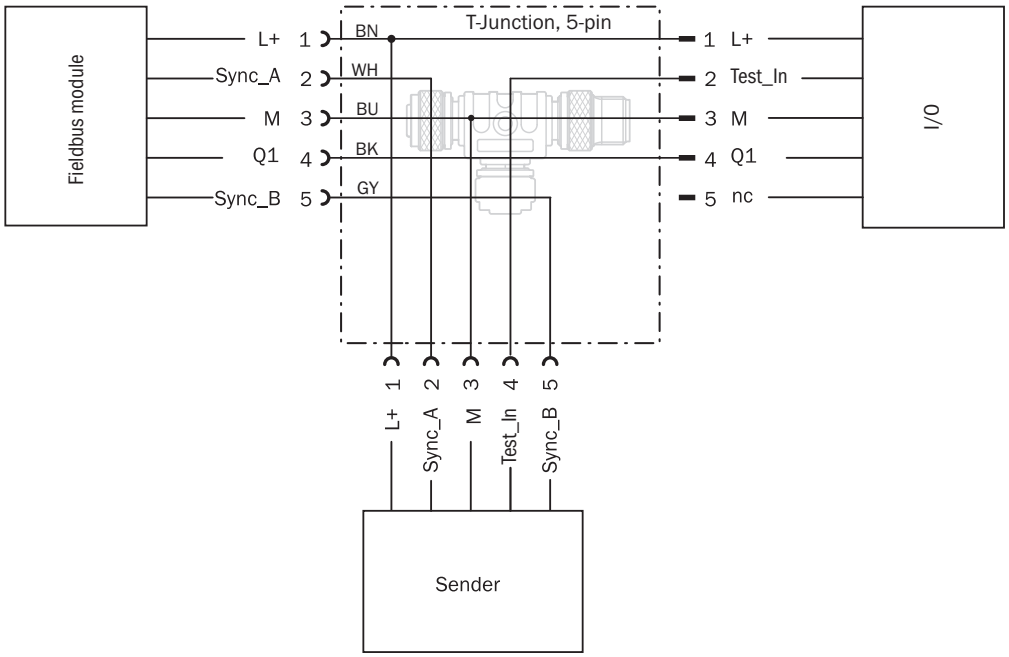
① Connection cable receiver (2096010)
② T-piece
③ Connection cable (2096240)
④ connection receiver “DEVICE”
⑤ Connection cable “POWER” (2096010)
⑥ Ethernet Connection cable “BUS IN, BUS OUT”
⑦ Ethernet connection cable “CONFIG”

ADJUSTMENTS



① status indicator: green, yellow, red LEDs

CONNECTION DIAGRAM T-PIECE



Further information as well as suitable accessories, example applications and downloads such as CAD dimensional models, operating instructions and software can be found at www.sick.com/1150333

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SICK AT A GLANCE

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